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Cleaning Instructions for small components used for the module construction in the OT

Subsequently the procedure to clean small components used in the construction of detector modules for the LHCb OT is described. These instruction apply to the cleaning of endblocks, middle blocks, wire locators, gas blocks and gas strips.

During the cleaning procedure and after cleaning the components **MUST NOT BE TOUCHED BY BARE HANDS. WEAR LATEX GLOVES WHENEVER TOUCHING CLEANED COMPONENTS!**

1. Fill ultrasonic bath with clean ethanol.
2. Fill components to be cleaned into the ultrasonic bath.
3. Switch on ultrasonic bath for 1-2minutes.
4. Remove components from ultrasonic bath.
5. Heat components for 30minutes in an oven at 40°C.
6. Fill components back to clean plastic bags.